

DATASHEET

SMD • B EAST1608RGA0



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

- The SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.



Device Selection Guide

Code	Chip Materials	Emitted Color	Resin Color	
R6	AlGalnP	Brilliant Red	M/hita Diffusad	
GH	InGaN	Brilliant Green	 White Diffused 	

Absolute Maximum Ratings (Ta=25°C)

Parameter Parameter	Symbol	Code	Rating	Unit	
Reverse Voltage	V_R		5	V	
Farmer Comment	l _F	R6	25	A	
Forward Current		GH	25	- mA	
Peak Forward Current	I _{FP}	R6	60		
(Duty 1/10 @1KHz)		GH	100	─ mA	
Dawar Dissination	D4	R6	60		
Power Dissipation	Pd	GH	95	- mW	
Electrostatic Dischause	F0D	R6	2000	v	
Electrostatic Discharge	ESD _{HBM}	GH	150	- V	
Operating Temperature	T _{opr}		-40 ~ +85	$^{\circ}$ C	
Storage Temperature	Tstg		-40 ~ +90	$^{\circ}\mathbb{C}$	
Soldering Temperature	Tsol		Reflow Soldering : 260 $^{\circ}$ C for 10 sec. Hand Soldering : 350 $^{\circ}$ C for 3 sec.		



Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Code	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	R6	28.5		72.0	— mcd	
		GH	72.0		180	mod	
Viewing Angle	2θ _{1/2}			130		deg	
Dook Woyalangth	à n	R6		632		— nm	— I _F =10mA
Peak Wavelength	λp	GH		518		11111	
Dominant Wavelength	λd	R6	615		625	nm	
		GH	520		535	— nm	
Spectrum Radiation Bandwidth	Δλ	R6		20			
		GH		35		— nm	
Forward Voltage	V _F	R6	1.7	2.0	2.4	— V	
		GH	2.7	3.3	3.7	V	
Reverse Current	I _R	R6			10	— μΑ	V _R =5V
		GH			50	μΑ	v _R -5v

Note:

1. Tolerance of Luminous Intensity: ±11%

3. Tolerance of Forward Voltage: ±0.10V

^{2.} Tolerance of Dominant Wavelength ±1nm



R6

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
N	28.5	45.0	man al	I -40m A
Р	45.0	72.0	mcd	I _F =10mA

GH

Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
Q1	72.0	90.0		
Q2	90.0	112		I 40 A
R1	112	140	— mcd	I _F =10mA
R2	140	180	_	

Bin Range Of Dom. Wavelength

Bin Code	Min.	Max.	Unit	Condition
1	520	525		
2	525	530	nm	I _F =10mA
3	530	535		

Note:

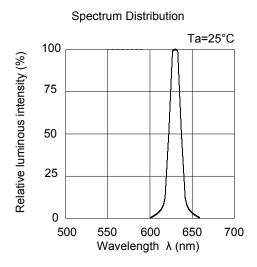
^{1.}Tolerance of Luminous Intensity: ±11%

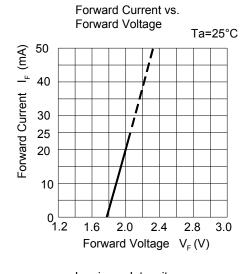
^{2.}Tolerance of Dominant Wavelength ±1nm

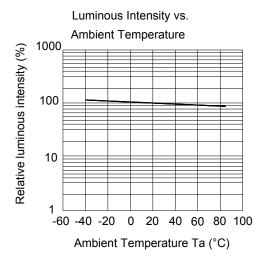


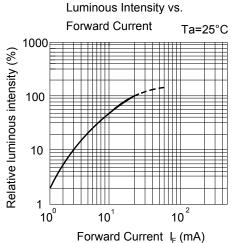
Typical Electro-Optical Characteristics Curves

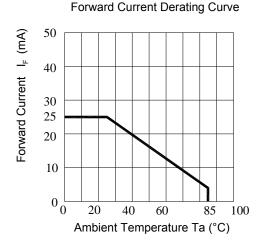
R6

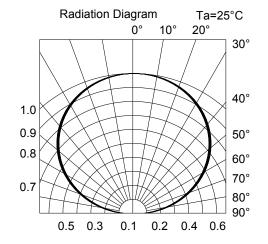








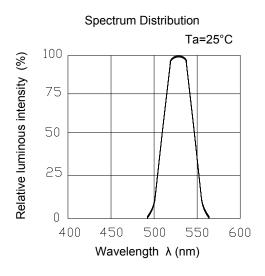


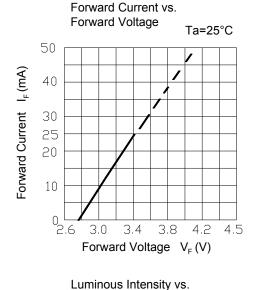


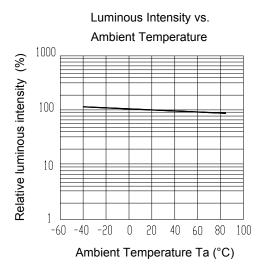


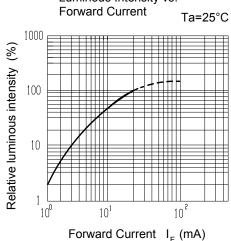
Typical Electro-Optical Characteristics Curves

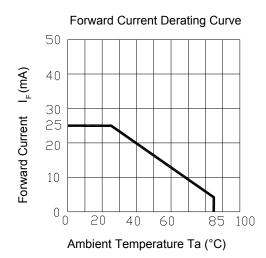
GH

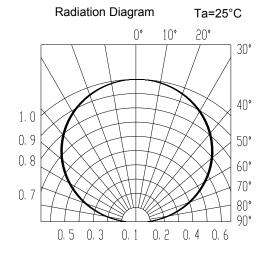






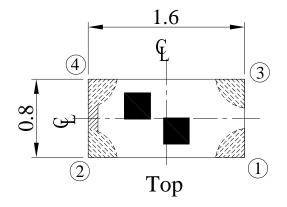


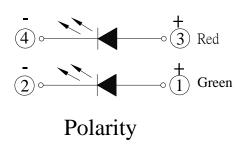


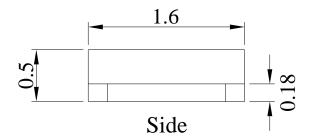


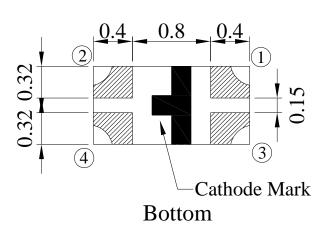


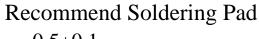
Package Dimension

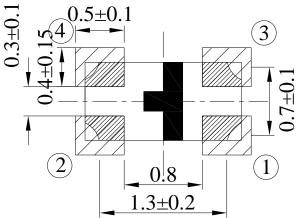










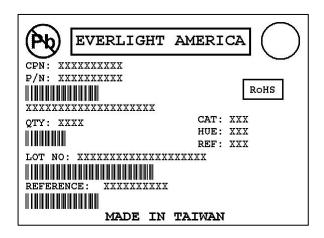


Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

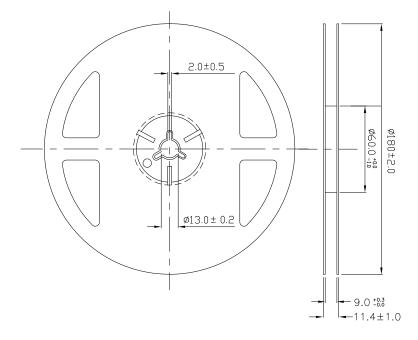


Label Explanation



- · CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- · REF: Forward Voltage Rank
- · LOT No: Lot Number

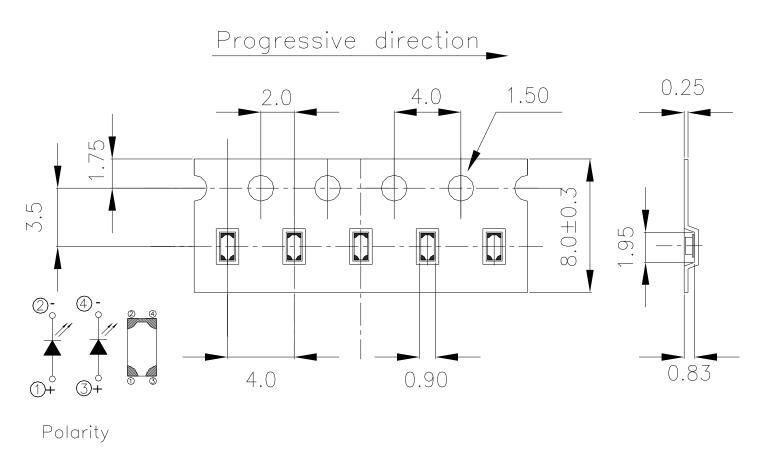
Reel Dimensions



Note: The tolerances unless mentioned is $\,\pm 0.1 mm$,Unit = mm

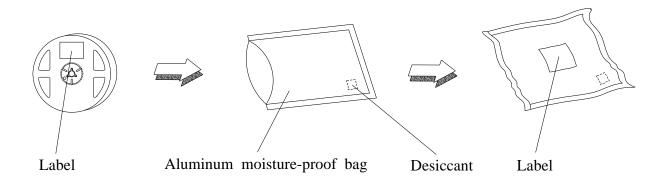


Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Moisture Resistant Packaging





Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

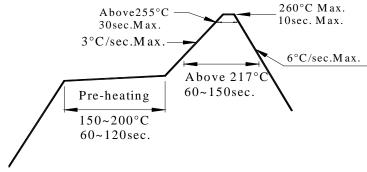
- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30℃ or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile



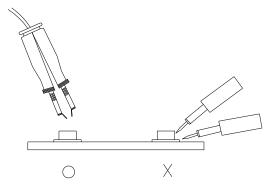
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight Americas before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.